

# PMV130ENEAR Datasheet



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DiGi Electronics Part Number	PMV130ENEAR-DG
Manufacturer	<a href="#">Nexperia USA Inc.</a>
Manufacturer Product Number	PMV130ENEAR
Description	MOSFET N-CH 40V 2.1A TO236AB
Detailed Description	N-Channel 40 V 2.1A (Ta) 460mW (Ta), 5W (Tc) Surface Mount TO-236AB



Tel: +00 852-30501935

RFQ Email: [Info@DiGi-Electronics.com](mailto:Info@DiGi-Electronics.com)

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## Purchase and inquiry

### Manufacturer Product Number:

PMV130ENEAR

### Series:

-

### FET Type:

N-Channel

### Drain to Source Voltage (Vdss):

40 V

### Drive Voltage (Max Rds On, Min Rds On):

4.5V, 10V

### Vgs(th) (Max) @ Id:

2.5V @ 250µA

### Vgs (Max):

±20V

### FET Feature:

-

### Operating Temperature:

-55°C ~ 150°C (Tj)

### Qualification:

AEC-Q100

### Supplier Device Package:

TO-236AB

### Base Product Number:

PMV130

### Manufacturer:

Nexperia USA Inc.

### Product Status:

Active

### Technology:

MOSFET (Metal Oxide)

### Current - Continuous Drain (Id) @ 25°C:

2.1A (Ta)

### Rds On (Max) @ Id, Vgs:

120mOhm @ 1.5A, 10V

### Gate Charge (Qg) (Max) @ Vgs:

3.6 nC @ 10 V

### Input Capacitance (Ciss) (Max) @ Vds:

170 pF @ 20 V

### Power Dissipation (Max):

460mW (Ta), 5W (Tc)

### Grade:

Automotive

### Mounting Type:

Surface Mount

### Package / Case:

TO-236-3, SC-59, SOT-23-3

## Environmental & Export classification

### RoHS Status:

ROHS3 Compliant

### REACH Status:

REACH Unaffected

### HTSUS:

8541.29.0095

### Moisture Sensitivity Level (MSL):

1 (Unlimited)

### ECCN:

EAR99



# PMV130ENEA

40 V, N-channel Trench MOSFET

10 April 2019

Product data sheet

## 1. General description

N-channel enhancement mode Field-Effect Transistor (FET) in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

## 2. Features and benefits

- Logic-level compatible
- Extended temperature range  $T_j = 175\text{ °C}$
- Trench MOSFET technology
- ElectroStatic Discharge (ESD) protection > 1 kV HBM (class H1C)
- AEC-Q101 qualified

## 3. Applications

- Relay driver
- High-speed line driver
- Low-side load switch
- Switching circuits

## 4. Quick reference data

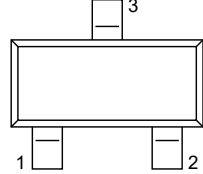
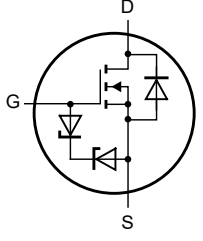
Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{DS}$	drain-source voltage	$T_j = 25\text{ °C}$	-	-	40	V
$V_{GS}$	gate-source voltage		-20	-	20	V
$I_D$	drain current	$V_{GS} = 10\text{ V}; T_{amb} = 25\text{ °C}$	[1]	-	2.1	A
<b>Static characteristics</b>						
$R_{DS(on)}$	drain-source on-state resistance	$V_{GS} = 10\text{ V}; I_D = 1.5\text{ A}; T_j = 25\text{ °C}$	-	95	120	m $\Omega$

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.

## 5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate	 <p>TO-236AB (SOT23)</p>	 <p>017aaa255</p>
2	S	source		
3	D	drain		

## 6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PMV130ENEA	TO-236AB	plastic surface-mounted package; 3 leads	SOT23

## 7. Marking

Table 4. Marking codes

Type number	Marking code <sup>[1]</sup>
PMV130ENEA	%JX

[1] % = placeholder for manufacturing site code

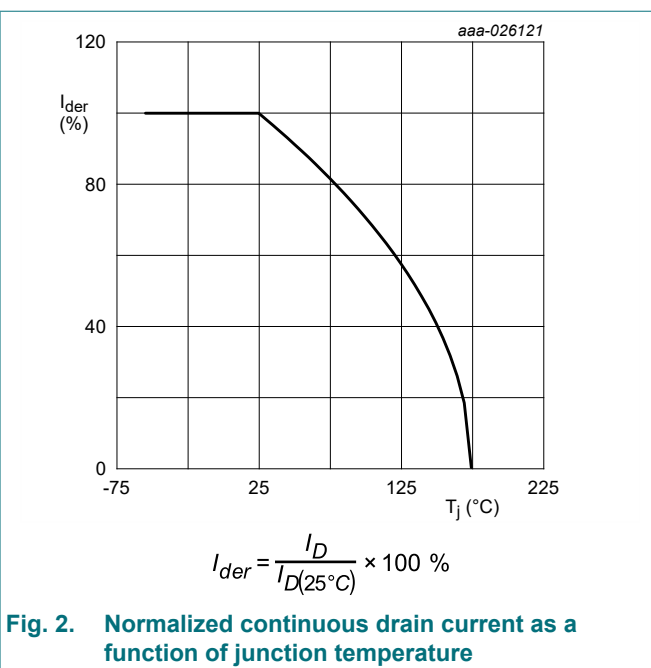
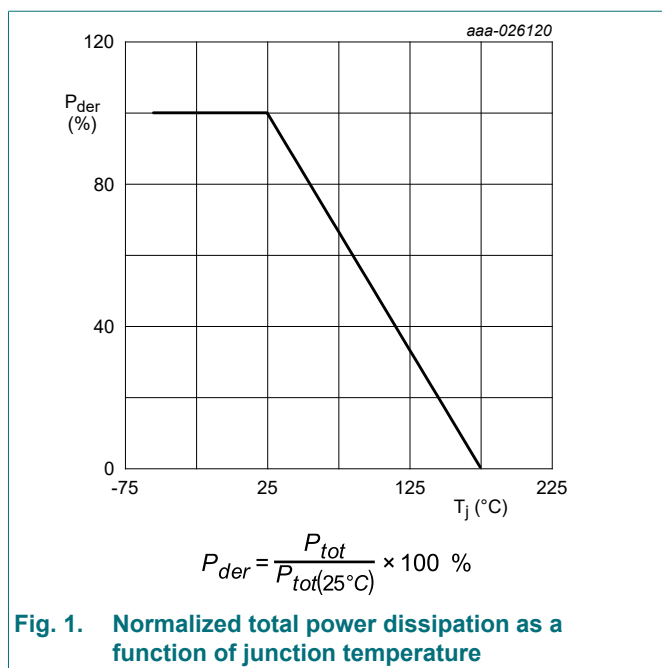
## 8. Limiting values

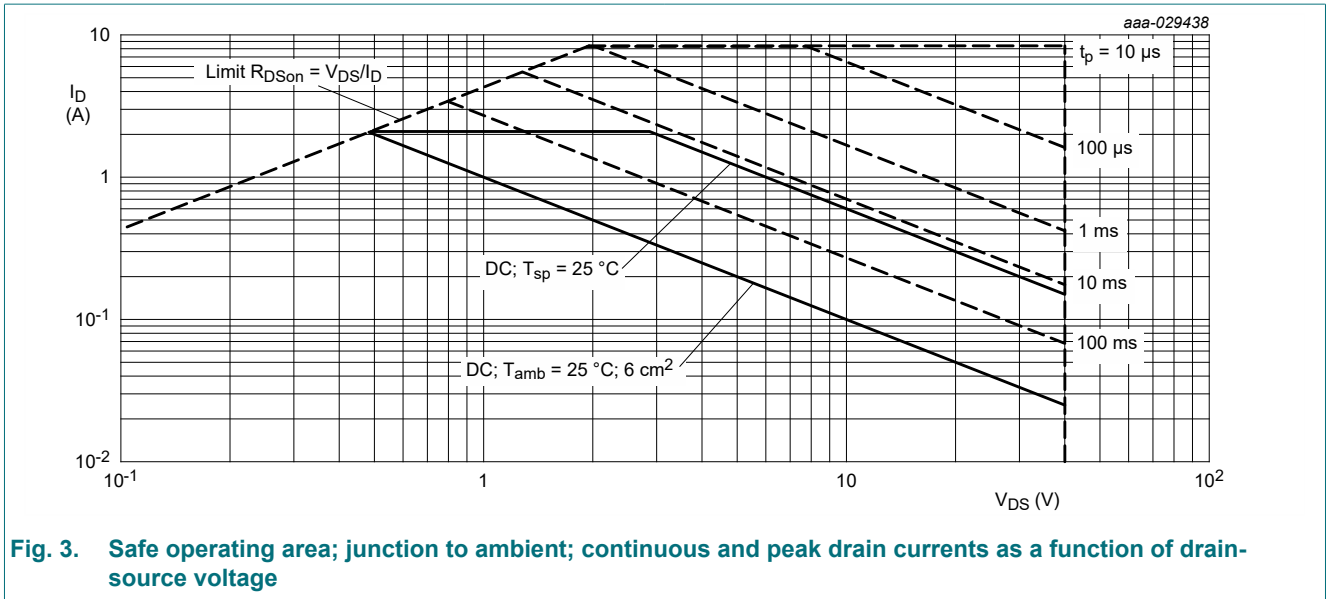
**Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_{DS}$	drain-source voltage	$T_j = 25\text{ }^\circ\text{C}$		-	40	V
$V_{GS}$	gate-source voltage			-20	20	V
$I_D$	drain current	$V_{GS} = 10\text{ V}; T_{amb} = 25\text{ }^\circ\text{C}$	[1]	-	2.1	A
		$V_{GS} = 10\text{ V}; T_{amb} = 100\text{ }^\circ\text{C}$	[1]	-	1.5	A
$I_{DM}$	peak drain current	$T_{amb} = 25\text{ }^\circ\text{C};$ single pulse; $t_p \leq 10\text{ }\mu\text{s}$		-	8	A
$P_{tot}$	total power dissipation	$T_{amb} = 25\text{ }^\circ\text{C}$	[2]	-	556	mW
			[1]	-	1	W
		$T_{sp} = 25\text{ }^\circ\text{C}$		-	6	W
$T_j$	junction temperature			-55	175	$^\circ\text{C}$
$T_{amb}$	ambient temperature			-55	175	$^\circ\text{C}$
$T_{stg}$	storage temperature			-65	175	$^\circ\text{C}$
<b>Source-drain diode</b>						
$I_S$	source current	$T_{amb} = 25\text{ }^\circ\text{C}$	[1]	-	1	A
<b>ESD maximum rating</b>						
$V_{ESD}$	electrostatic discharge voltage	HBM	[3]	-	1000	V
<b>Avalanche ruggedness</b>						
$E_{DS(AL)S}$	non-repetitive drain-source avalanche energy	$T_{j(\text{init})} = 25\text{ }^\circ\text{C}; I_D = 0.26\text{ A};$ DUT in avalanche (unclamped)		-	5.8	mJ

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.  
 [2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.  
 [3] Measured between all pins.





### 9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	235	270	K/W
			[2]	-	125	150	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point			-	20	25	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.

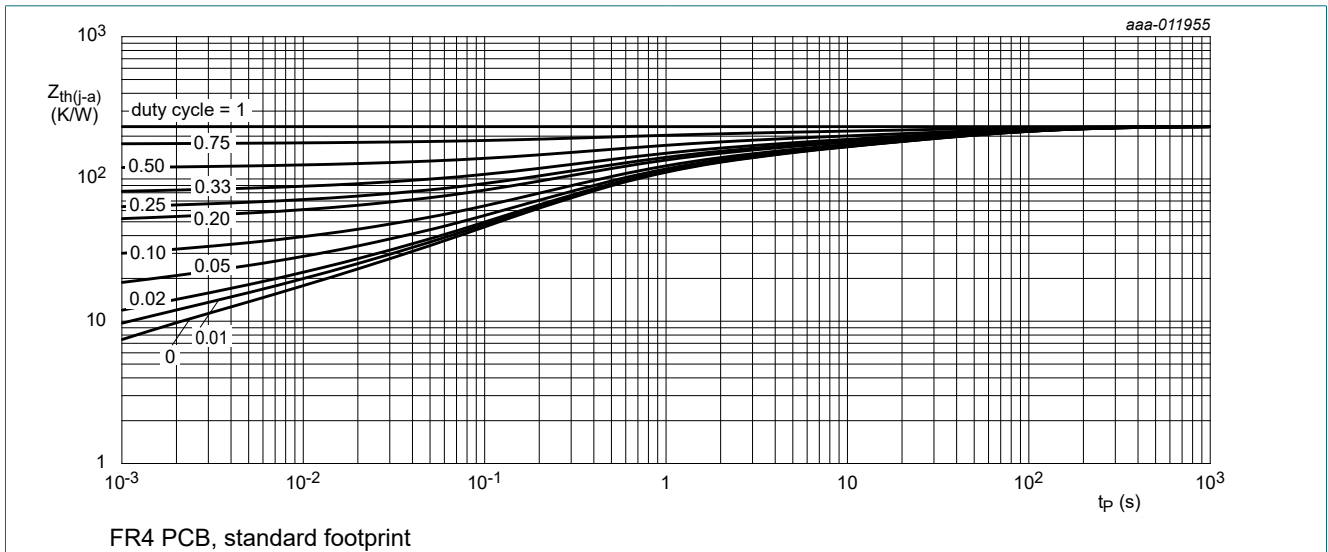


Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

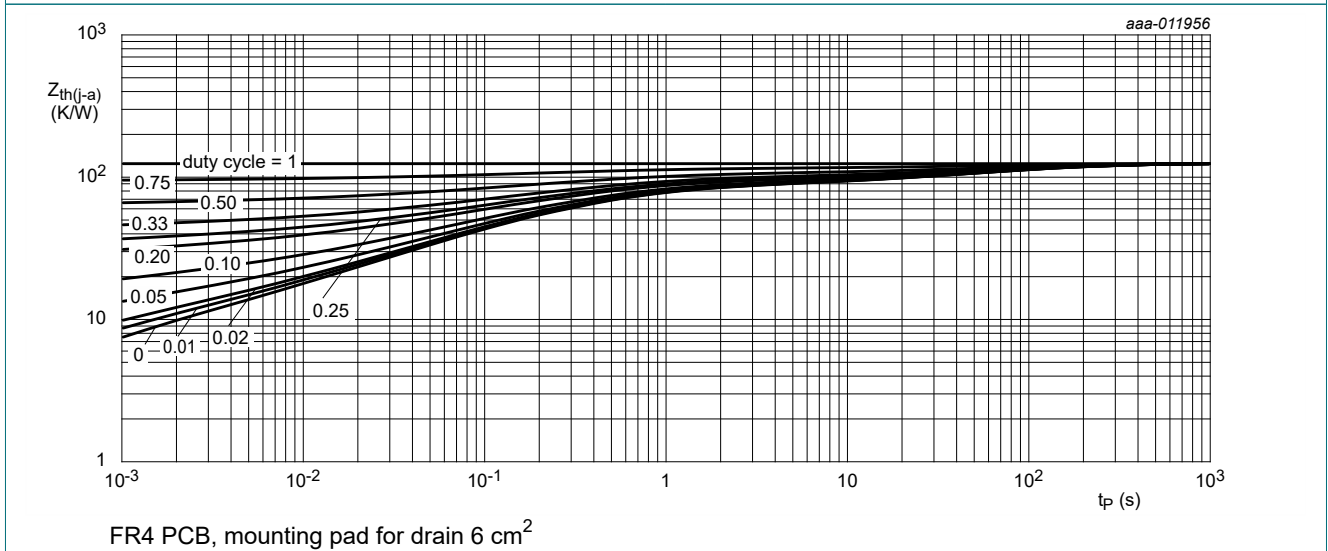


Fig. 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

## 10. Characteristics

**Table 7. Characteristics**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Static characteristics</b>						
$V_{(BR)DSS}$	drain-source breakdown voltage	$I_D = 250 \mu A; V_{GS} = 0 V; T_j = 25 \text{ }^\circ C$	40	-	-	V
$V_{GSth}$	gate-source threshold voltage	$I_D = 250 \mu A; V_{DS} = V_{GS}; T_j = 25 \text{ }^\circ C$	1	1.6	2.5	V
$I_{DSS}$	drain leakage current	$V_{DS} = 40 V; V_{GS} = 0 V; T_j = 25 \text{ }^\circ C$	-	-	1	$\mu A$
		$V_{DS} = 40 V; V_{GS} = 0 V; T_j = 150 \text{ }^\circ C$	-	-	20	$\mu A$
$I_{GSS}$	gate leakage current	$V_{GS} = 20 V; V_{DS} = 0 V; T_j = 25 \text{ }^\circ C$	-	-	10	$\mu A$
		$V_{GS} = -20 V; V_{DS} = 0 V; T_j = 25 \text{ }^\circ C$	-	-	-10	$\mu A$
$R_{DSon}$	drain-source on-state resistance	$V_{GS} = 10 V; I_D = 1.5 A; T_j = 25 \text{ }^\circ C$	-	95	120	m $\Omega$
		$V_{GS} = 10 V; I_D = 1.5 A; T_j = 175 \text{ }^\circ C$	-	184	233	m $\Omega$
		$V_{GS} = 4.5 V; I_D = 1 A; T_j = 25 \text{ }^\circ C$	-	120	160	m $\Omega$
$g_{fs}$	forward transconductance	$V_{DS} = 10 V; I_D = 2 A; T_j = 25 \text{ }^\circ C$	-	4.5	-	S
$R_G$	gate resistance	$f = 1 \text{ MHz}$	-	28	-	$\Omega$
<b>Dynamic characteristics</b>						
$Q_{G(tot)}$	total gate charge	$V_{DS} = 20 V; I_D = 1.5 A; V_{GS} = 10 V; T_j = 25 \text{ }^\circ C$	-	2.4	3.6	nC
$Q_{GS}$	gate-source charge		-	0.3	-	nC
$Q_{GD}$	gate-drain charge		-	0.4	-	nC
$C_{iss}$	input capacitance	$V_{DS} = 20 V; f = 1 \text{ MHz}; V_{GS} = 0 V; T_j = 25 \text{ }^\circ C$	-	113	170	pF
$C_{oss}$	output capacitance		-	27	-	pF
$C_{rss}$	reverse transfer capacitance		-	14	-	pF
$t_{d(on)}$	turn-on delay time	$V_{DS} = 20 V; I_D = 1.5 A; V_{GS} = 10 V; R_{G(ext)} = 6 \Omega; T_j = 25 \text{ }^\circ C$	-	6	9	ns
$t_r$	rise time		-	8	-	ns
$t_{d(off)}$	turn-off delay time		-	11	17	ns
$t_f$	fall time		-	3	-	ns
<b>Source-drain diode</b>						
$V_{SD}$	source-drain voltage	$I_S = 1 A; V_{GS} = 0 V; T_j = 25 \text{ }^\circ C$	-	0.8	1.2	V
$t_{rr}$	reverse recovery time	$I_S = 1 A; dI_S/dt = -100 A/\mu s; V_{GS} = 0 V; V_{DS} = 20 V; T_j = 25 \text{ }^\circ C$	-	7.3	-	ns
$Q_r$	recovered charge	$V_{DS} = 20 V; T_j = 25 \text{ }^\circ C$	-	2	-	nC



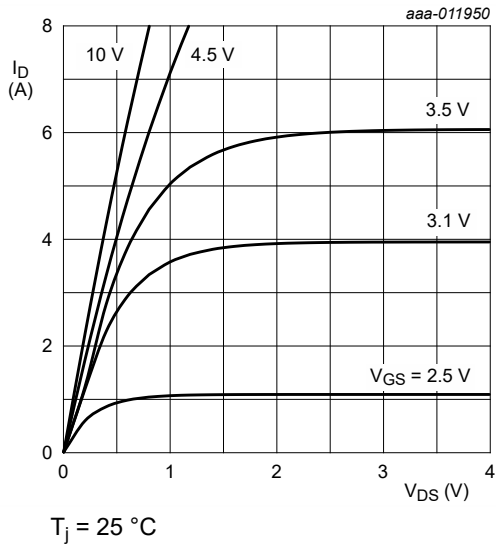


Fig. 6. Output characteristics: drain current as a function of drain-source voltage; typical values

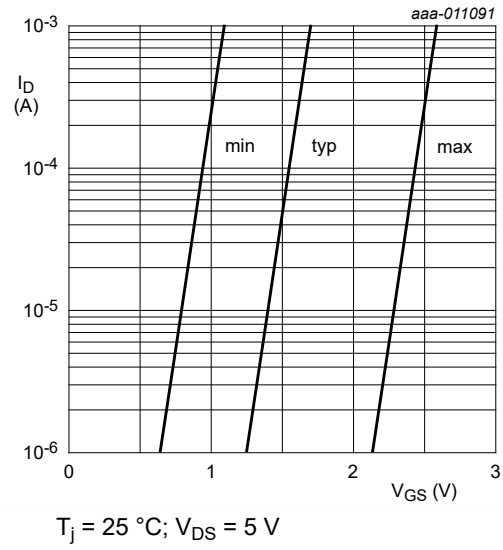


Fig. 7. Sub-threshold drain current as a function of gate-source voltage

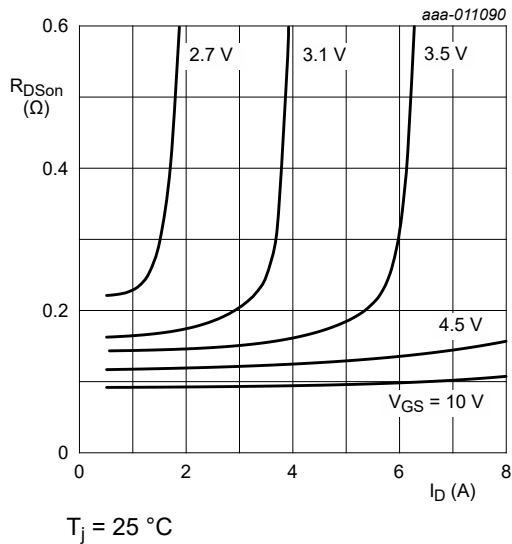


Fig. 8. Drain-source on-state resistance as a function of drain current; typical values

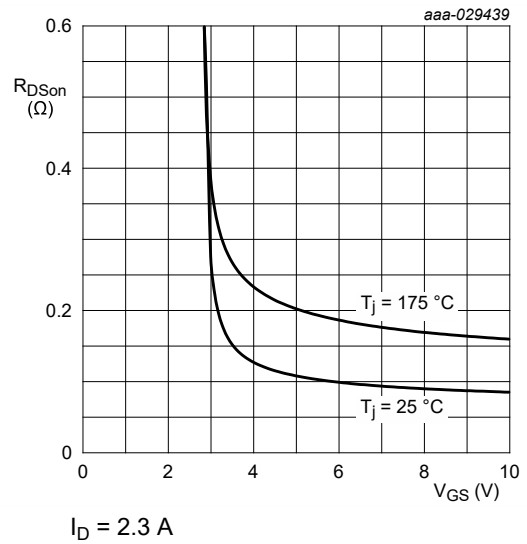
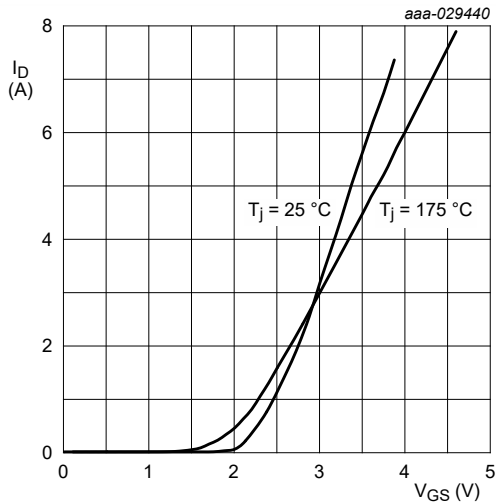
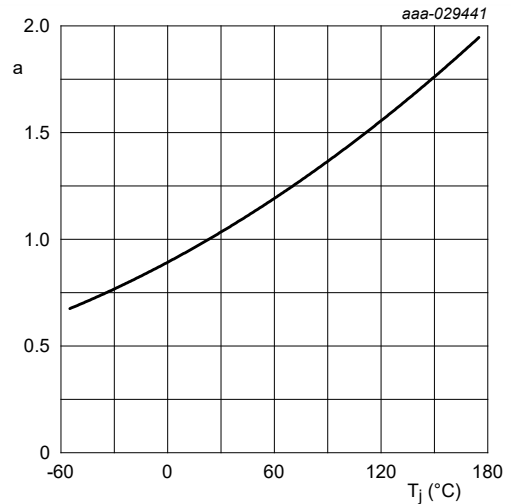


Fig. 9. Drain-source on-state resistance as a function of gate-source voltage; typical values



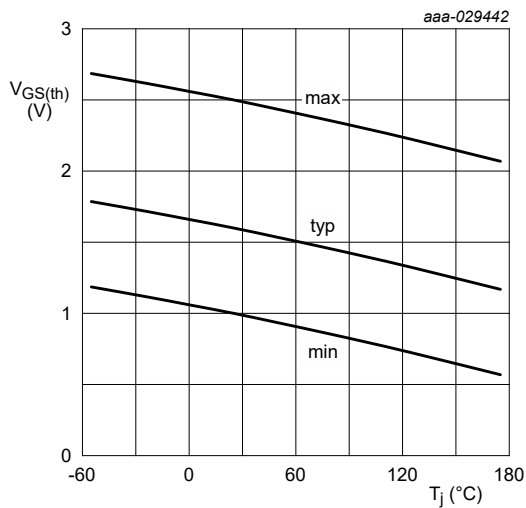
$$V_{DS} > I_D \times R_{DSon}$$

**Fig. 10. Transfer characteristics: drain current as a function of gate-source voltage; typical values**



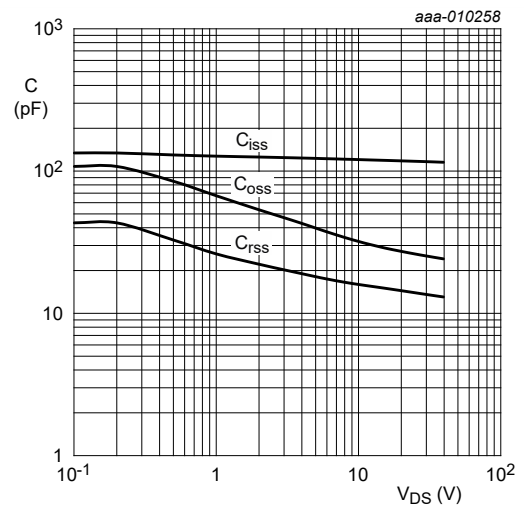
$$a = \frac{R_{DSon}}{R_{DSon(25^\circ C)}}$$

**Fig. 11. Normalized drain-source on-state resistance as a function of junction temperature; typical values**



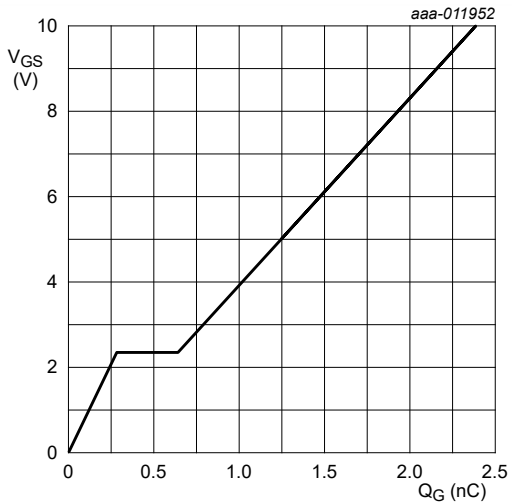
$$I_D = 250\mu A; V_{DS} = V_{GS}$$

**Fig. 12. Gate-source threshold voltage as a function of junction temperature**



$$f = 1 \text{ MHz}; V_{GS} = 0 \text{ V}$$

**Fig. 13. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values**



$I_D = 1.5 \text{ A}; V_{DS} = 20 \text{ V}; T_{amb} = 25 \text{ }^\circ\text{C}$

Fig. 14. Gate-source voltage as a function of gate charge; typical values

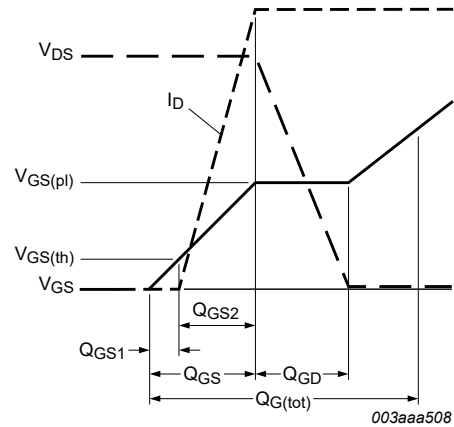
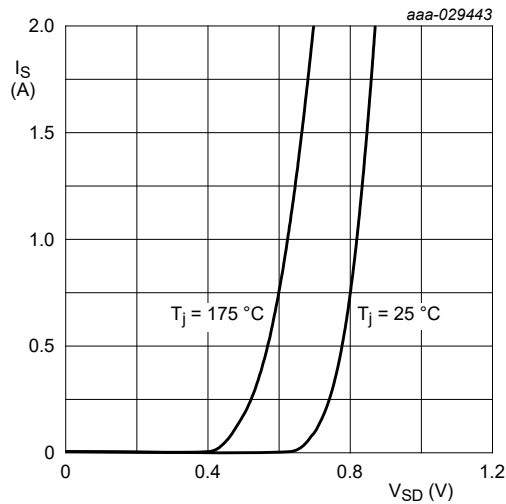


Fig. 15. Gate charge waveform definitions



$V_{GS} = 0 \text{ V}$

Fig. 16. Source current as a function of source-drain voltage; typical values

## 11. Test information

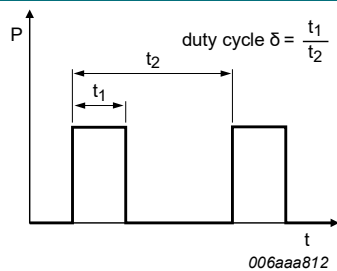


Fig. 17. Duty cycle definition

### Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline

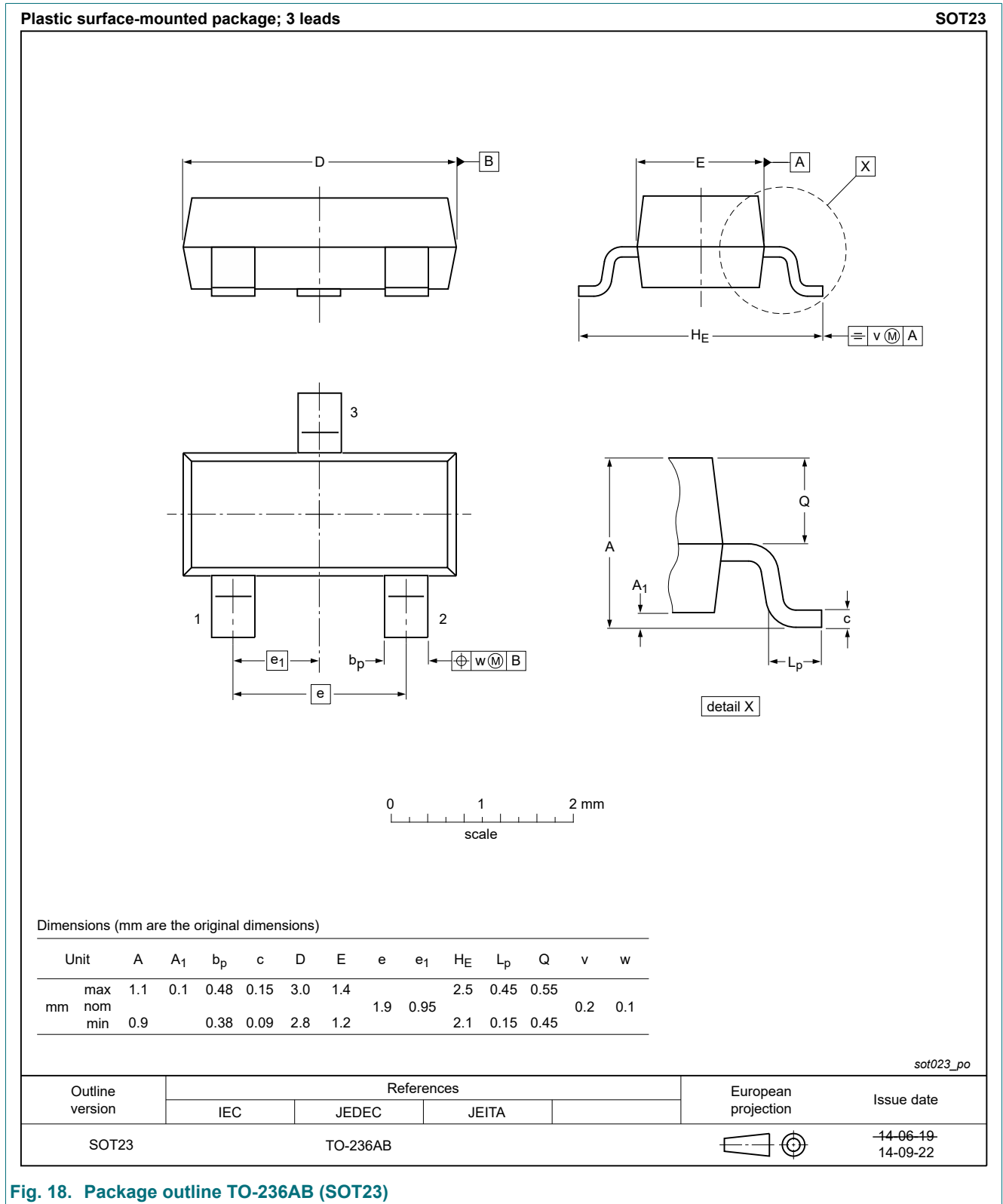


Fig. 18. Package outline TO-236AB (SOT23)

### 13. Soldering

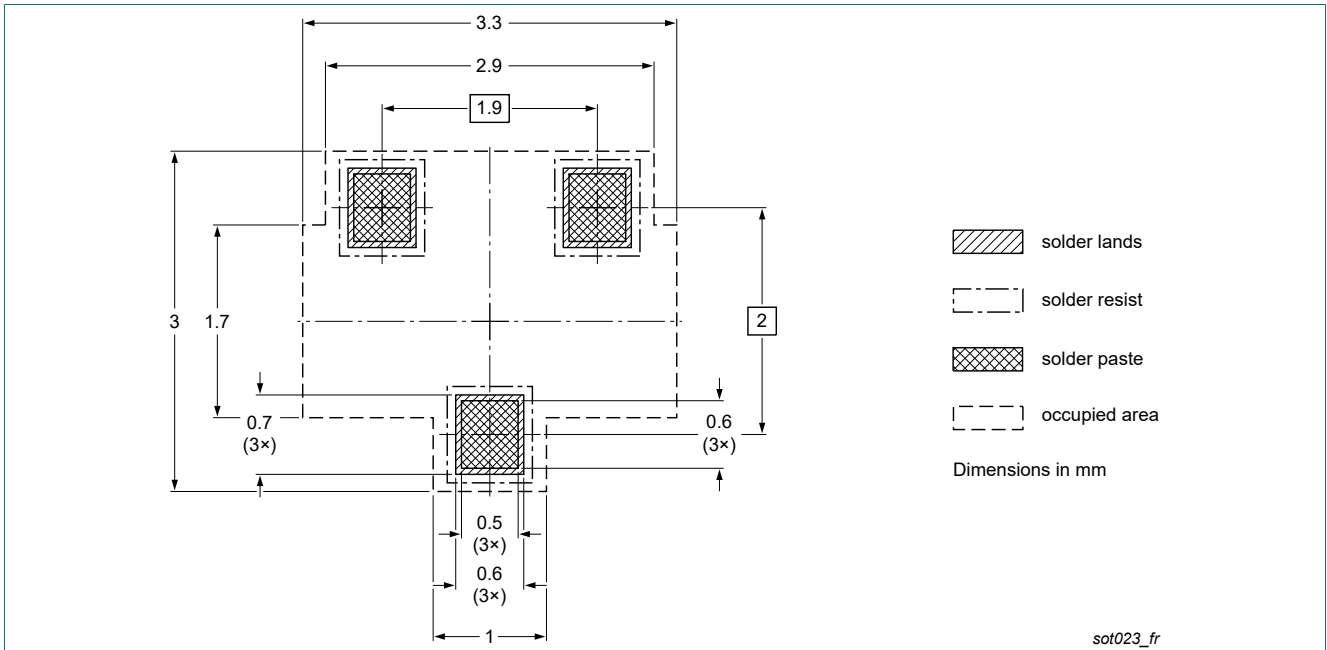


Fig. 19. Reflow soldering footprint for TO-236AB (SOT23)

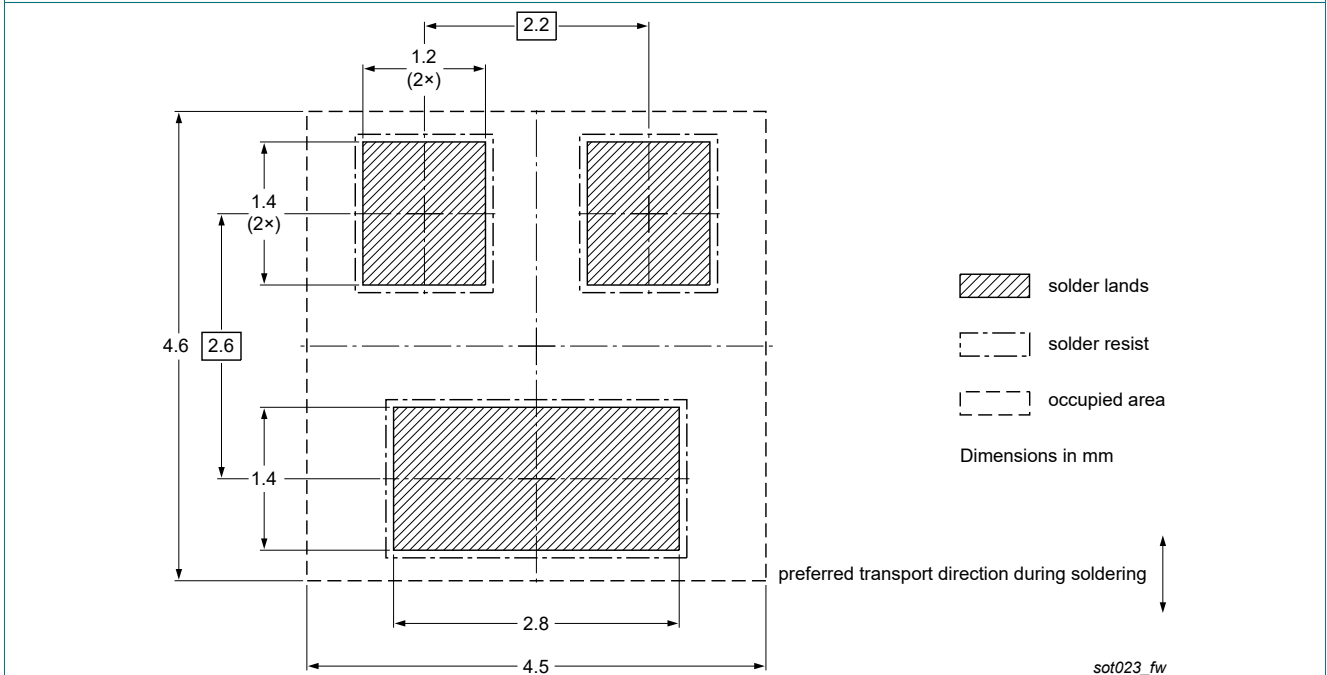


Fig. 20. Wave soldering footprint for TO-236AB (SOT23)

## 14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMV130ENEA v.4	20190410	Product data sheet	-	PMV130ENEA v.3
Modifications:	<ul style="list-style-type: none"> <li>Change from the temperature range <math>T_j = 150\text{ °C}</math> to the extended temperature range <math>T_j = 175\text{ °C}</math>.</li> </ul>			
PMV130ENEA v.3	20180705	Product data sheet	-	PMV130ENEA v.2
PMV130ENEA v.2	20140612	Product data sheet	-	PMV130ENEA v.1
PMV130ENEA v.1	20140313	Preliminary data sheet	-	-

## 15. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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 Date of release: 10 April 2019

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